Supporting Information

Unusual Thermal Transport Behavior in Self-Assembled Fullerene Nanorods

Hao Tang^{1,2}, Kunpeng Dou³, Yucheng Xiong^{1,2}, Feng Wang⁴, Yang Zhao⁵, Xiaomeng

Wang^{1,2}, Qiang Fu^{1,2}, Juekuan Yang⁵, Ni Zhao⁴, and Dongyan Xu^{1,2,*}

¹ Department of Mechanical and Automation Engineering, The Chinese University of

Hong Kong, Shatin, New Territories, Hong Kong Special Administrative Region

² Shenzhen Research Institute, The Chinese University of Hong Kong, Shenzhen,

518057, China

³ Research Center for Applied Sciences, Academia Sinica, Taipei 11529, Taiwan

⁴ Department of Electronic Engineering, The Chinese University of Hong Kong, Shatin, New Territories, Hong Kong Special Administrative Region

⁵ School of Mechanical Engineering and Jiangsu Key Laboratory for Design and Manufacture of Micro-Nano Biomedical Instruments, Southeast University, Nanjing, 211189, China

^{*}E-mail: <u>dyxu@mae.cuhk.edu.hk</u>



Figure S1 The SEM image of a suspended device



Figure S2 (a) The SEM image of a C_{60} nanorod placed onto a suspended device (Sample 2); (b) the SEM image of Sample 2 with Pt/C composites deposited at the contacts between the nanorod and Pt electrodes by EBID; (c) temperature-dependent thermal resistances of Sample 2 before and after EBID.